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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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## MOS FIELD EFFECT TRANSISTOR $\mu$ PA1717

### SWITCHING P-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The  $\mu$ PA1717 is P-Channel MOS Field Effect Transistor designed for power management applications of notebook computers.

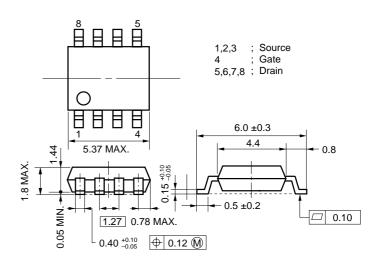
#### **FEATURES**

- · Low on-state resistance
  - $R_{DS(on)1} = 33~m\Omega~MAX.~(V_{GS} = -10~V,~I_{D} = -3~A)$   $R_{DS(on)2} = 59~m\Omega~MAX.~(V_{GS} = -4.5~V,~I_{D} = -3~A)$
- Low Ciss: Ciss = 830 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

#### **ORDERING INFORMATION**

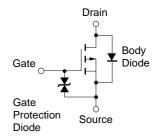
PART NUMBER	PACKAGE
μPA1717G	Power SOP8

#### PACKAGE DRAWING (Unit: mm)



#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, All terminals are connected.) EQUIVALENT CIRCUIT

Drain to Source Voltage (Vgs = 0 V)	Voss	-30	V
Gate to Source Voltage (VDS = 0 V)	Vgss	∓ 25	V
Drain Current (DC)	ID(DC)	<b>∓</b> 6	Α
Drain Current (pulse) Note1	D(pulse)	∓ 24	Α
Total Power Dissipation $(T_A = 25^{\circ}C)^{Note2}$	Рт	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C



- **Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %
  - 2. Mounted on ceramic substrate of 1200 mm<sup>2</sup> x 2.2 mm

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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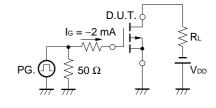
#### ELECTRICAL CHARACTERISTICS (TA = 25 °C, All terminals are connected.)

			_			
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = -10 V, ID = -3 A		26	33	mΩ
	RDS(on)2	Vgs = -4.5 V, lb = -3 A		44	59	mΩ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1 mA	-1.5	-2.0	-2.5	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -3 A	3.0	7.5		S
Drain Leakage Current	loss	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V			-1	μΑ
Gate to Source Leakage Current	Igss	Vss = ∓ 25 V, Vbs = 0 V			∓ 10	μΑ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		830		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		330		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		130		pF
Turn-on Delay Time	td(on)	Ib = -3 A		15		ns
Rise Time	tr	$V_{GS(on)} = -10 \text{ V}$		120		ns
Turn-off Delay Time	td(off)	V <sub>DD</sub> = -15 V		70		ns
Fall Time	t <sub>f</sub>	$R_G = 6 \Omega$		50		ns
Total Gate Charge	Q <sub>G</sub>	Ib = -6 A		15		nC
Gate to Source Charge	Qgs	V <sub>DD</sub> = -24 V		3		nC
Gate to Drain Charge	Q <sub>GD</sub>	V <sub>G</sub> S = -10 V		5		nC
Body Diode Forward Voltage	VF(S-D)	IF = 6 A, VGS = 0 V		0.82		V
Reverse Recovery Time	trr	IF = 6 A, VGS = 0 V		35		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A / μs		15		nC

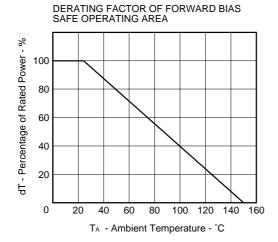
#### **TEST CIRCUIT 1 SWITCHING TIME**

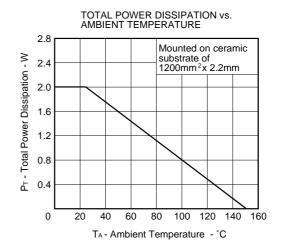
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#### **TEST CIRCUIT 2 GATE CHARGE**



#### TYPICAL CHARACTERISTICS (TA = 25 °C)



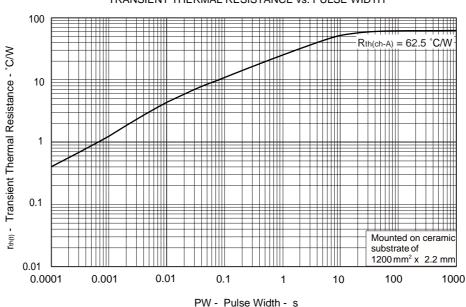


# FORWARD BIAS SAFE OPERATING AREA -100 -1

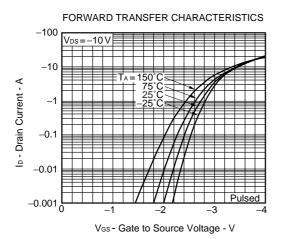
V<sub>DS</sub> - Drain to Source Voltage - V

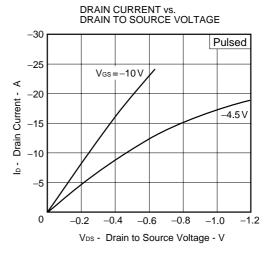
**Remark** Mounted on ceramic substrate of 1200 mm<sup>2</sup> x 2.2 mm

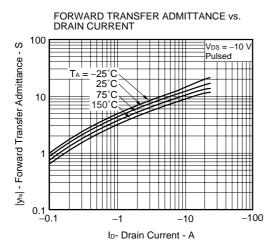
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

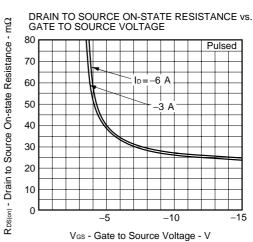


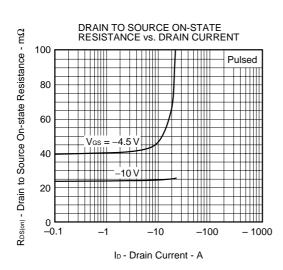
3

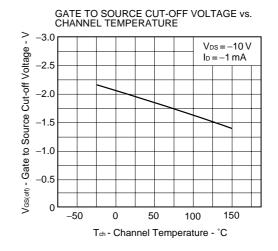


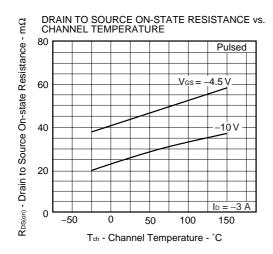


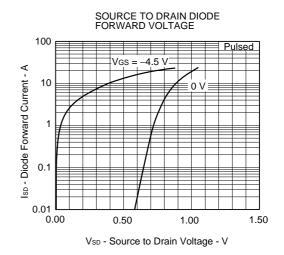


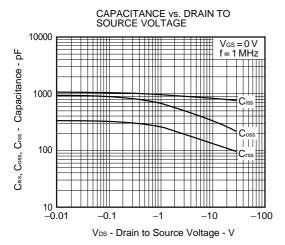


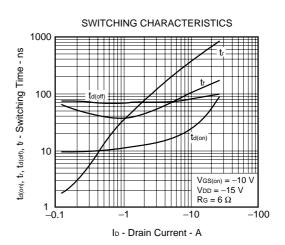


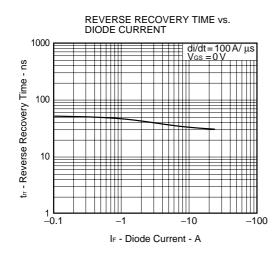


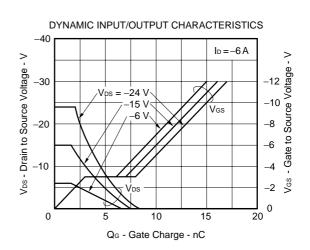












[MEMO]

NEC  $\mu$ PA1717

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